

ASSIGNMENT RECORD
-PATENT

10-14-2004



102858461

To: Honorable Commissioner of Patents and Trademarks.

Please record the attached original document or copy thereof.

1. Name of conveying parties:

- a) Yezdi Dordi
- b) Bob Maraschin
- c) John Boyd
- d) Fred C. Redeker
- e) Carl Woods

2. Name and address of receiving party:

- a) Name: Lam Research Corporation
- b) Address: 4650 Cushing Parkway, Fremont, CA 94538

3. Nature of conveyance

- | | |
|--|--|
| <input checked="" type="checkbox"/> Assignment | <input type="checkbox"/> Merger |
| <input type="checkbox"/> Security Agreement | <input type="checkbox"/> Change of Name |
| <input type="checkbox"/> Other _____ | <input type="checkbox"/> License Agreement |

Execution Dates:

- a) June 24, 2004
- b) June 28, 2004
- c) June 23, 2004
- d) June 23, 2004
- e) June 24, 2004

4. Application Number: 10/879,263

The title of the new application is: **METHOD AND APPARATUS FOR PLATING SEMICONDUCTOR WAFERS**

5. Please send all correspondence concerning this document to:

Kenneth D. Wright
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710 Lakeway Drive, Suite 170
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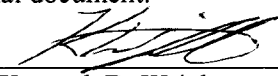
6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41): \$40.00

- ☒ Enclosed
- ☒ Commissioner is authorized to charge any deficiencies to Deposit Account No. 50-0805 (Order No. LAM2P485)

8. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Date: October 6, 2004


Kenneth D. Wright
Reg. No. 53,795

10/13/2004 DBYRME 00000054 10879263

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40.00 DP

Attorney Docket No. LAM2P485/P1294

(Revised 01/96)

PATENT
REEL: 015872 FRAME: 0629

OFFICE OF PUBLIC RECORDS
2004 OCT 12 AM 9:31
FINANCE SECTION

10/12/04

ASSIGNMENT OF PATENT APPLICATION

(Accompanying Application)

Whereas we the undersigned inventors have invented certain new and useful improvements as set forth in the patent application entitled:

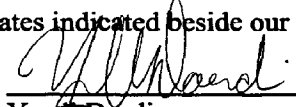

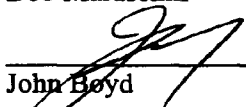
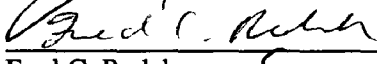
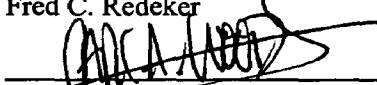
METHOD AND APPARATUS FOR PLATING SEMICONDUCTOR WAFERS

(Atty. Docket No. LAM2P485/P1294) for which we have executed an application for a United States Letters Patent.

For good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, we the undersigned inventors hereby:

- 1) Sell, assign and transfer to Lam Research Corporation, a Delaware corporation having a place of business at 4650 Cushing Parkway, Fremont, CA 94538, (hereinafter referred to as "ASSIGNEE"), the entire right title and interest in any and all improvements and inventions disclosed in, application(s) based upon, and Patent(s) (including foreign patents) granted upon the information which is disclosed in the above referenced application.
- 2) Authorize and request the Commissioner of Patents to issue any and all Letters Patents resulting from said application or any division(s), continuation(s), substitutes(s) or reissue(s) thereof to the ASSIGNEE.
- 3) Agree to execute all papers and documents and, entirely at the ASSIGNEE's expense, perform any acts which are reasonably necessary in connection with the prosecution of said application, as well as any derivative and applications thereof, foreign applications based thereon, and/or the enforcement of patents resulting from such applications.
- 4) Agree that the terms, covenants and conditions of this assignment shall inure to the benefit of the Assignee, its successors, assigns and other legal representative, and shall be binding upon the inventor(s), as well as the inventor's heirs, legal representatives and assigns.
- 5) Warrant and represent that I have not entered, and will not enter into any assignment, contract, or understanding that conflicts with this assignment.

Signed on the dates indicated beside our signatures.

1)	Signature: <u></u>	Date: <u>June 24, 2004</u>
	Typed Name: Yezdi Dordi	
2)	Signature: <u></u>	Date: <u>JUNE 28, 2004</u>
	Typed Name: Bob Maraschin	
3)	Signature: <u></u>	Date: <u>06/23/04</u>
	Typed Name: John Boyd	
4)	Signature: <u></u>	Date: <u>6/23/04</u>
	Typed Name: Fred C. Redeker	
5)	Signature: <u></u>	Date: <u>06/24/04</u>
	Typed Name: Carl Woods	

Attorney Docket No. LAM2P485/P1294

RECORDED: 10/12/2004

PATENT
REEL: 015872 FRAME: 0630